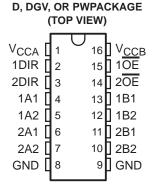
## SN74AVCH4T245 4-BIT DUAL-SUPPLY BUS TRANSCEIVER

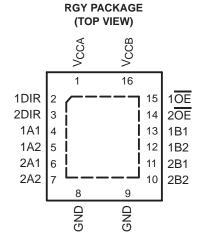
# WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTP

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- Control Inputs VIH/VIL Levels are Referenced to V<sub>CCA</sub> Voltage
- **Fully Configurable Dual-Rail Design Allows** Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant

- Ioff Supports Partial-Power-Down Mode Operation
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22** 
  - 8000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)





#### description/ordering information

This 4-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V<sub>CCA</sub>. V<sub>CCA</sub> accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V<sub>CCB</sub>. V<sub>CCB</sub> accepts any supply voltage from 1.2 V to 3.6 V. The SN74AVCH4T245 is optimized to operate with  $V_{CCA}/V_{CCB}$  set at 1.4 V to 3.6 V. It is operational with  $V_{CCA}/V_{CCB}$  as low as 1.2 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCH4T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCH4T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V<sub>CCA</sub>.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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### description/ordering information (continued)

#### ORDERING INFORMATION

TA	PACKA	\GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	QFN – RGY	Tape and reel	SN74AVCH4T245RGYR	WS245
	0010 B	Tube	SN74AVCH4T245D	AVOLUTO 45
-40°C to 85°C	SOIC – D	Tape and reel	SN74AVCH4T245DR	AVCH4T245
-40 C to 65 C	TOOOD DW	Tube	SN74AVCH4T245PW	W0045
	TSSOP – PW	Tape and reel	SN74AVCH4T245PWR	WS245
	TVSOP - DGV	Tape and reel	SN74AVCH4T245DGVR	WS245

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, then both ports are in the high-impedance state. The bus-hold circuitry on the powered-up side always stays active.

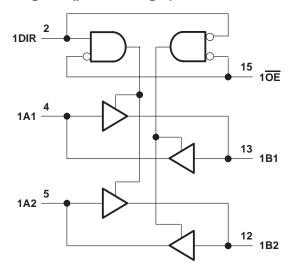
Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

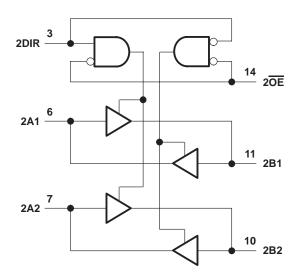
To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

# FUNCTION TABLE (each 4-bit section)

INP	UTS	
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	All output Hi-Z

### logic diagram (positive logic)







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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

$ \begin{array}{llllllllllllllllllllllllllllllllllll$
Voltage range applied to any output in the high-impedance or power-off state, VO
(see Note 1): (A port)
(B port)
Voltage range applied to any output in the high or low state, V <sub>O</sub>
(see Notes 1 and 2): (A port)
(B port)
Input clamp current, $I_{IK}$ ( $V_I < 0$ )
Output clamp current, $I_{OK}$ ( $V_O < 0$ )
Continuous output current, I <sub>O</sub> ±50 mA
Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND
Package thermal impedance, θ <sub>JA</sub> (see Note 3): D package
(see Note 3): DGV package 120°C/W
(see Note 3): PW package
(see Note 4): RGY package
Storage temperature range, T <sub>stg</sub> –65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.
  - 4. The package thermal impedance is calculated in accordance with JESD 51-5.



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### recommended operating conditions (see Notes 5 through 7)

			VCCI	Vcco	MIN	MAX	UNIT
VCCA	Supply voltage				1.2	3.6	V
VCCB	Supply voltage				1.2	3.6	V
	18.1.1.1.1	5	1.2 V to 1.95 V		V <sub>CCI</sub> × 0.65		
$\vee_{IH}$	High-level input voltage	Data inputs (see Note 8)	1.95 V to 2.7 V		1.6		V
	voltago	(000 11010 0)	2.7 V to 3.6 V		2		
		5	1.2 V to 1.95 V			$V_{CCI} \times 0.35$	
$\vee_{IL}$	Low-level input voltage	Data inputs (see Note 8)	1.95 V to 2.7 V			0.7	V
	Tonago	(655 ) (655	2.7 V to 3.6 V			0.8	
	LPak Laval Parasi	DIR	1.2 V to 1.95 V		$V_{CCA} \times 0.65$		
$\vee_{IH}$	High-level input voltage	(referenced to V <sub>CCA</sub> )	1.95 V to 2.7 V		1.6		V
	voltago	(see Note 9)	2.7 V to 3.6 V		2		
		DIR	1.2 V to 1.95 V			$V_{CCA} \times 0.35$	
$\vee_{IL}$	Low-level input voltage	(referenced to VCCA)	1.95 V to 2.7 V			0.7	V
	voltago	(see Note 9)	2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
\/-	Output voltage	Active state			0	Vcco	V
VO	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
lOH	High-level output curre	nt		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
lOL	Low-level output currer	nt		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
$\Delta t/\Delta v$	Input transition rise or f	all rate				5	ns/V
TA	Operating free-air temp	perature			-40	85	°C

NOTES: 5.  $V_{CCI}$  is the  $V_{CC}$  associated with the data input port.

- 6. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
- 7. All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
- For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH(min)</sub> = V<sub>CCI</sub> x 0.7 V, V<sub>IL(max)</sub> = V<sub>CCI</sub> x 0.3 V.
   For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH(min)</sub> = V<sub>CCA</sub> x 0.7 V, V<sub>IL(max)</sub> = V<sub>CCA</sub> x 0.3 V.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Note 10)

						T,	Δ = 25°C	;	-40°C to	85°C	
PARAM	ETER	TEST CONDIT	IONS	VCCA	VCCB	MIN	TYP	MAX	MIN	MAX	UNIT
		I <sub>OH</sub> = -100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V				Vcco-0	).2 V	
		IOH = -3  mA		1.2 V	1.2 V		0.95				
,,		I <sub>OH</sub> = -6 mA	],, ,,	1.4 V	1.4 V				1.05		.,
VOH		$I_{OH} = -8 \text{ mA}$	VI = VIH	1.65 V	1.65 V				1.2		V
		$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
		$I_{OH} = -12 \text{ mA}$		3 V	3 V				2.3		
		I <sub>OL</sub> = 100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
		IOL = 3  mA		1.2 V	1.2 V		0.15				
V		IOL = 6 mA	,, ,,	1.4 V	1.4 V					0.35	.,
$V_{OL}$		I <sub>OL</sub> = 8 mA	$V_I = V_{IL}$	1.65 V	1.65 V					0.45	V
		$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V					0.55	
		I <sub>OL</sub> = 12 mA		3 V	3 V					0.7	
1.	DIR input	V <sub>I</sub> = V <sub>CCA</sub> or GND		1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μΑ
		V <sub>I</sub> = 0.42 V		1.2 V	1.2 V		25				
		V <sub>I</sub> = 0.49 V		1.4 V	1.4 V				15		
I <sub>BHL</sub> †		V <sub>I</sub> = 0.58 V		1.65 V	1.65 V				25		μΑ
		V <sub>I</sub> = 0.7 V		2.3 V	2.3 V				45		
		V <sub>I</sub> = 0.8 V		3.3 V	3.3 V				100		
		V <sub>I</sub> = 0.78 V		1.2 V	1.2 V		-25				
		V <sub>I</sub> = 0.91 V		1.4 V	1.4 V				-15		
I <sub>BHH</sub> ‡		V <sub>I</sub> = 1.07 V		1.65 V	1.65 V				-25		μΑ
		V <sub>I</sub> = 1.6 V		2.3 V	2.3 V				-45		
		V <sub>I</sub> = 2 V		3.3 V	3.3 V				-100		
				1.2 V	1.2 V		50				
				1.6 V	1.6 V				125		
IBHLO§		V <sub>I</sub> = 0 to V <sub>CCI</sub>		1.95 V	1.95 V				200		μΑ
				2.7 V	2.7 V				300		
				3.6 V	3.6 V				500		
				1.2 V	1.2 V		-50				
			ļ		1.6 V				-125		
IBHHO¶		V <sub>I</sub> = 0 to V <sub>CCI</sub>	1.95 V	1.95 V				-200		μА	
			2.7 V	2.7 V				-300			
				3.6 V	3.6 V				-500		

<sup>†</sup> The bus-hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>IN</sub> to GND and then raising it to V<sub>IL</sub> max.

NOTE 10: V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.



<sup>&</sup>lt;sup>‡</sup> The bus-hold circuit can source at least the minimum high sustaining current at V<sub>IH</sub> min. I<sub>BHH</sub> should be measured after raising V<sub>IN</sub> to V<sub>CC</sub> and then lowering it to V<sub>IH</sub> min.

<sup>§</sup> An external driver must source at least I<sub>BHLO</sub> to switch this node from low to high.

<sup>¶</sup> An external driver must sink at least IBHHO to switch this node from high to low.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Notes 11 and 12) (continued)

5454		TEST SOUDIT	0110	.,	,,	T,	4 = 25°C	;	-40°C t	o 85°C		
PARA	METER	TEST CONDIT	ONS	VCCA	VCCB	MIN	TYP	MAX	MIN	MAX	UNIT	
1	A port	\\. a \\ - 0 to 2 C \\		0 V	0 to 3.6 V		±0.1	±1		±5	^	
l <sub>off</sub>	B port	$V_{I}$ or $V_{O} = 0$ to 3.6 V		0 to 3.6 V	0 V		±0.1	±1		±5	μΑ	
	A or B port	$V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND	OE = VIH	3.6 V	3.6 V		±0.5	±2.5		±5	μΑ	
loz†	B port	$V_O = V_{CCO}$ or GND,	OE =	0 V	3.6 V					±5		
	A port	$V_I = V_{CCI}$ or GND	don't care	3.6 V	0 V					±5	μΑ	
	•			1.2 V to 3.6 V	1.2 V to 3.6 V					8		
ICCA		V <sub>I</sub> = V <sub>CCI</sub> or GND	IO = 0	0 V	3.6 V					-2	μΑ	
				3.6 V	0 V					8		
				1.2 V to 3.6 V	1.2 V to 3.6 V					8		
ICCB		V <sub>I</sub> = V <sub>CCI</sub> or GND	IO = 0	0 V	3.6 V					8	μΑ	
				3.6 V	0 V					-2		
ICCA +	⊦ I <sub>CCB</sub>	$V_I = V_{CCI}$ or GND	$I_O = 0$	1.2 V to 3.6 V	1.2 V to 3.6 V					16	μΑ	
Ci	Control inputs	V <sub>I</sub> = 3.3 V or GND		3.3 V	3.3 V		3.5			4.5	pF	
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 3.3 V or GND		3.3 V	3.3 V		6			7	pF	

<sup>&</sup>lt;sup>†</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

NOTES: 11.  $V_{\mbox{CCO}}$  is the  $V_{\mbox{CC}}$  associated with the output port.

# switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 11)

PARAMETER	FROM (INPUT)	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = 1.5 V ± 0.1 V	V <sub>CCB</sub> = 1.8 V ± 0.15 V	V <sub>CCB</sub> = 2.5 V ± 0.2 V	V <sub>CCB</sub> = 3.3 V ± 0.3 V	UNIT
	(INPUI)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	
tPLH	٨		3.4	2.9	2.7	2.6	2.8	
t <sub>PHL</sub>	Α	В	3.4	2.9	2.7	2.6	2.8	ns
t <sub>PLH</sub>			3.6	3.1	2.8	2.6	2.6	
t <sub>PHL</sub>	В	Α	3.6	3.1	2.8	2.6	2.6	ns
t <sub>PZH</sub>	ŌĒ	Δ.	5.6	4.7	4.3	3.9	3.7	
tPZL	OE	Α	5.6	4.7	4.3	3.9	3.7	ns
t <sub>PZH</sub>	ŌĒ	В	5	4.3	3.9	3.6	3.6	
tPZL	OE	В	5	4.3	3.9	3.6	3.6	ns
t <sub>PHZ</sub>	ŌĒ		6.2	5.2	5.2	4.3	4.8	
t <sub>PLZ</sub>	OE	Α	6.2	5.2	5.2	4.3	4.8	ns
t <sub>PHZ</sub>	ŌĒ		5.9	5.1	5	4.7	5.5	
<sup>t</sup> PLZ	OE	В	5.9	5.1	5	4.7	5.5	ns

<sup>12.</sup> V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.

# SN74AVCH4T245 **4-BIT DUAL-SUPPLY BUS TRANSCEIVER** WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS SCESS77A – JUNE 2004 – REVISED APRIL 2005

### switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 1.5 V \pm 0.1 V$ (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> =		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> =		V <sub>CCB</sub> =		UNIT												
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX													
t <sub>PLH</sub>	А	В	3.2	0.3	6.3	0.3	5.2	0.4	4.2	0.4	4.2													
t <sub>PHL</sub>	А	В	3.2	0.3	6.3	0.3	5.2	0.4	4.2	0.4	4.2	ns												
t <sub>PLH</sub>	6	Δ.	3.3	0.7	6.3	0.5	6	0.4	5.7	0.3	5.6													
t <sub>PHL</sub>	В	В	В	В	R	B	А	3.3	0.7	6.3	0.5	6	0.4	5.7	0.3	5.6	ns							
<sup>t</sup> PZH	ŌĒ	Δ.	4.9	1.4	9.6	1.1	9.5	0.7	9.4	0.4	9.4													
t <sub>PZL</sub>	OE	А	4.9	1.4	9.6	1.1	9.5	0.7	9.4	0.4	9.4	ns												
<sup>t</sup> PZH	<del></del>		4.5	1.4	9.6	1.1	7.7	0.9	5.8	0.9	5.6													
tPZL	ŌĒ	В	4.5	1.4	9.6	1.1	7.7	0.9	5.8	0.9	5.6	ns												
t <sub>PHZ</sub>	<del></del>	Δ.	5.6	1.8	10.2	1.5	10.2	1.3	10.2	1.6	10.2													
t <sub>PLZ</sub>	OE	ŌE A	5.6	1.8	10.2	1.5	10.2	1.3	10.2	1.6	10.2	ns												
t <sub>PHZ</sub>	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	- B	5.2	1.9	10.3	1.9	9.1	1.4	7.4	1.2	7.6						
t <sub>PLZ</sub>									ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	DE B	5.2	1.9

## switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 1.8 V $\pm$ 0.15 V (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> =		V <sub>CCB</sub> = ± 0.3		UNIT																			
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																				
<sup>t</sup> PLH	Δ.		2.9	0.1	6	0.1	4.9	0.1	3.9	0.3	3.9																				
<sup>t</sup> PHL	Α	В	2.9	0.1	6	0.1	4.9	0.1	3.9	0.3	3.9	ns																			
<sup>t</sup> PLH	В	^	3	0.6	5.3	0.5	4.9	0.3	4.6	0.3	4.5																				
<sup>t</sup> PHL	В	А	3	0.6	5.3	0.5	4.9	0.3	4.6	0.3	4.5	ns																			
<sup>t</sup> PZH	ŌĒ		4.4	1	7.4	1	7.3	0.6	7.3	0.4	7.2																				
tPZL	OE	А	4.4	1	7.4	1	7.3	0.6	7.3	0.4	7.2	ns																			
<sup>t</sup> PZH	ŌĒ	В	4.1	1.2	9.2	1	7.4	0.8	5.3	0.8	4.6																				
tPZL	OE	В	4.1	1.2	9.2	1	7.4	0.8	5.3	0.8	4.6	ns																			
<sup>t</sup> PHZ	<u> </u>	^	5.4	1.6	8.6	1.8	8.7	1.3	8.7	1.6	8.7																				
t <sub>PLZ</sub>	ŌĒ	Α	Α	Α	A	5.4	1.6	8.6	1.8	8.7	1.3	8.7	1.6	8.7	ns																
<sup>t</sup> PHZ	<u> </u>		<u>-</u>		1.7	9.9	1.6	8.7	1.2	6.9	1	6.9																			
<sup>t</sup> PLZ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	В	5	1.7	9.9	1.6	8.7	1.2	6.9	1	6.9	ns

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# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 2.5 V $\pm$ 0.2 V (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> =		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> =		V <sub>CCB</sub> =		UNIT											
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX												
t <sub>PLH</sub>	٨	В	2.8	0.1	5.7	0.1	4.6	0.2	3.5	0.1	3.6												
t <sub>PHL</sub>	Α	В	2.8	0.1	5.7	0.1	4.6	0.2	3.5	0.1	3.6	ns											
t <sub>PLH</sub>	В		2.7	0.6	4.2	0.4	3.9	0.2	3.4	0.2	3.3												
t <sub>PHL</sub>	В	А	2.7	0.6	4.2	0.4	3.9	0.2	3.4	0.2	3.3	ns											
<sup>t</sup> PZH	ŌĒ	А	4	0.7	6.5	0.7	5.2	0.6	4.8	0.4	4.8												
t <sub>PZL</sub>	OE		4	0.7	6.5	0.7	5.2	0.6	4.8	0.4	4.8	ns											
<sup>t</sup> PZH	<u> -</u>		3.8	0.9	8.8	0.8	7	0.6	4.8	0.6	4												
tPZL	ŌĒ	В	3.8	0.9	8.8	0.8	7	0.6	4.8	0.6	4	ns											
t <sub>PHZ</sub>	<u></u>	Δ.	4.7	1	8.4	1	8.4	1	6.2	1	6.6												
tPLZ	OE	А	4.7	1	8.4	1	8.4	1	6.2	1	6.6	ns											
t <sub>PHZ</sub>	ŌĒ	<u></u>	4.5	1.5	9.4	1.3	8.2	1.1	6.2	0.9	5.2												
t <sub>PLZ</sub>		ŌĒ	OË	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	В	4.5	1.5	9.4	1.3	8.2	1.1	6.2	0.9	5.2

# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 3.3 V $\pm$ 0.3 V (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> =		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.3		UNIT														
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX															
t <sub>PLH</sub>	Δ.	В	2.9	0.1	5.6	0.1	4.5	0.1	3.3	0.1	2.9															
t <sub>PHL</sub>	Α	В	2.9	0.1	5.6	0.1	4.5	0.1	3.3	0.1	2.9	ns														
t <sub>PLH</sub>	В	Δ.	2.6	0.6	4.2	0.4	3.4	0.2	3	0.1	2.8															
t <sub>PHL</sub>	В В	Α	2.6	0.6	4.2	0.4	3.4	0.2	3	0.1	2.8	ns														
<sup>t</sup> PZH	ŌĒ		3.8	0.6	8.7	0.6	5.2	0.6	3.8	0.4	3.8															
tPZL	OE	Α	3.8	0.6	8.7	0.6	5.2	0.6	3.8	0.4	3.8	ns														
<sup>t</sup> PZH	ŌĒ	В	3.7	0.8	8.7	0.6	6.8	0.5	4.7	0.5	3.8															
tPZL	OE	В	3.7	0.8	8.7	0.6	6.8	0.5	4.7	0.5	3.8	ns														
t <sub>PHZ</sub>	<u></u>	Δ.	4.8	0.7	9.3	0.7	8.3	0.7	5.6	0.7	6.6															
tPLZ	ŌĒ	Α	4.8	0.7	9.3	0.7	8.3	0.7	5.6	0.7	6.6	ns														
t <sub>PHZ</sub>	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌE B		5.3	1.4	9.3	1.2	8.1	1	6.4	0.8	6.2	
t <sub>PLZ</sub>																ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	В

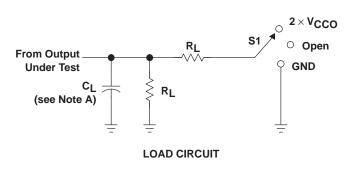
# SN74AVCH4T245 4-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS SCES577A - JUNE 2004 - REVISED APRIL 2005

# operating characteristics, $T_A = 25^{\circ}C$

Р	ARAMET	ER	TEST CONDITIONS	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V	UNIT
			CONDITIONS	TYP	TYP	TYP	TYP	TYP	
	Outputs Enabled			1	1	1	1.5	2	
Cut	AIOB	Outputs Disabled	C <sub>L</sub> = 0, f = 10 MHz,	1	1	1	1	1	, F
CpdA	C <sub>pdA</sub> † B to A	Outputs Enabled	$t_r = t_f = 1 \text{ ns}$	12	12.5	13	14	15	pF
		Outputs Disabled		1	1	1	1	1	
	A to B	Outputs Enabled		12	12.5	13	14	15	
c <sub>pdB</sub> †	AIOB	Outputs Disabled	C <sub>L</sub> = 0,	1	1	1	1	1	pF
□ ⊃bqB,	Outputs Enabled		f = 10  MHz, $t_{\Gamma} = t_{f} = 1 \text{ ns}$	1	1	1	1	2	þΓ
	B to A	Outputs Disabled		1	1	1	1	1	

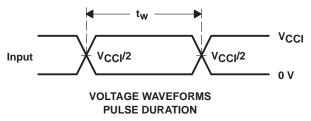
<sup>†</sup> Power dissipation capacitance per transceiver

#### PARAMETER MEASUREMENT INFORMATION



TEST	S1
t <sub>pd</sub>	Open
tPLZ/tPZL	2×V <sub>CCO</sub>
tPHZ/tPZH	GND

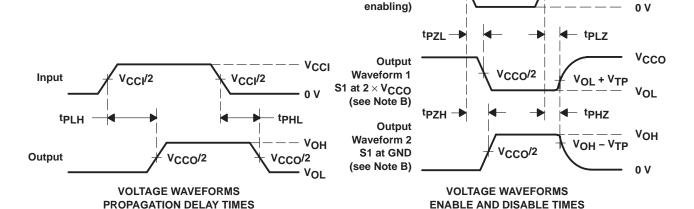
Vcco	CL	RL	V <sub>TP</sub>
1.2 V	15 pF	<b>2 k</b> Ω	0.1 V
1.5 V ± 0.1 V	15 pF	<b>2 k</b> Ω	0.1 V
1.8 V $\pm$ 0.15 V	15 pF	<b>2 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	15 pF	<b>2 k</b> Ω	0.15 V
3.3 V $\pm$ 0.3 V	15 pF	<b>2 k</b> Ω	0.3 V



V<sub>CCA</sub>/2

V<sub>CCA</sub>/2

VCCA



Output Control

(low-level

NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{O}$  = 50  $\Omega$ , dv/dt  $\geq$  1 V/ns, dv/dt ≥1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. VCCI is the VCC associated with the input port.
- I. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

Figure 1. Load Circuit and Voltage Waveforms



### PACKAGE OPTION ADDENDUM





### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
74AVCH4T245DGVRE4	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVCH4T245PWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVCH4T245PWTE4	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AVCH4T245RGYRG4	ACTIVE	QFN	RGY	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
SN74AVCH4T245D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DGVR	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245DTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245PWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245PWT	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVCH4T245RGYR	ACTIVE	QFN	RGY	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



### PACKAGE OPTION ADDENDUM

9-Aug-2005

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### DGV (R-PDSO-G\*\*)

### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

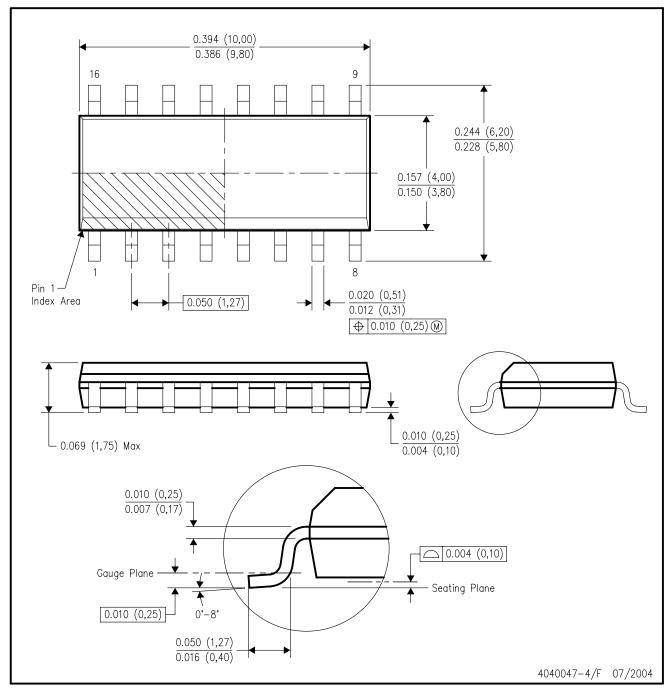
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

# D (R-PDSO-G16)

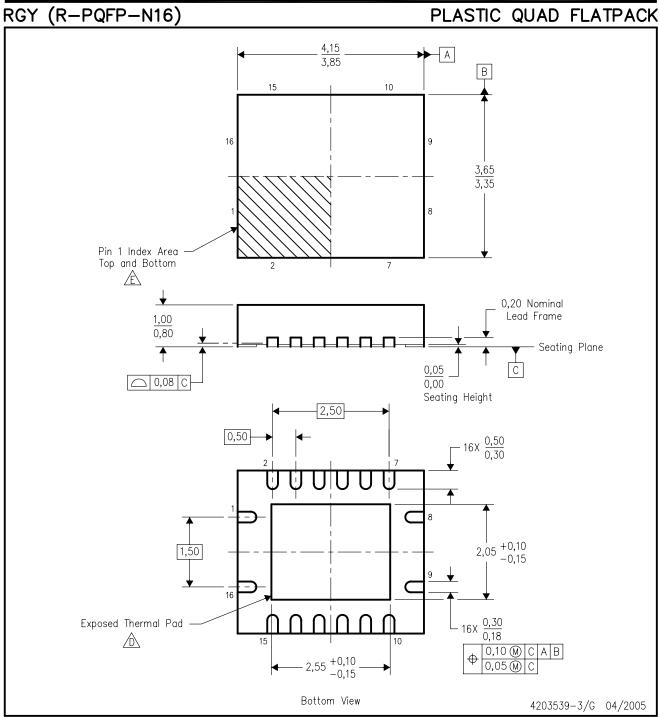
## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.





NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance.
- Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BB.



### PW (R-PDSO-G\*\*)

### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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